# TL499A WIDE-RANGE POWER-SUPPLY CONTROLLERS

SLVS029G - JANUARY 1984 - REVISED SEPTEMBER 2001

- Internal Series-Pass and Step-Up Switching Regulator
- Output Adjustable From 2.9 V to 30 V
- 1-V to 10-V Input for Switching Regulator
- 4.5-V to 32-V Input for Series Regulator
- Externally Controlled Switching Current
- No External Rectifier Required

# P OR PS PACKAGE (TOP VIEW) SERIES IN1 1 8 OUTPUT REF 2 7 GND (PWR) SW REG IN2 3 6 SW IN SW CURRENT CTRL 4 5 GND

# description

The TL499A is an integrated circuit designed to provide a wide range of adjustable regulated supply voltages. The regulated output voltage can be varied from 2.9 V to 30 V by adjusting two external resistors. When the TL499A is ac-coupled to line power through a step-down transformer, it operates as a series dc voltage regulator to maintain the regulated output voltage. With the addition of a battery from 1.1 V to 10 V, an inductor, a filter capacitor, and two resistors, the TL499A operates as a step-up switching regulator during an ac-line failure.

The adjustable regulated output voltage makes the TL499A useful for a wide range of applications. Providing backup power during an ac-line failure makes the TL499A extremely useful in microprocessor memory applications.

The TL499AC is characterized for operation from -20°C to 85°C.

### **AVAILABLE OPTIONS**

TA	PLASTIC DIP (P)	PLASTIC SMALL-OUTLINE (PS)
–20°C to 85°C	TL499ACP	TL499ACPS

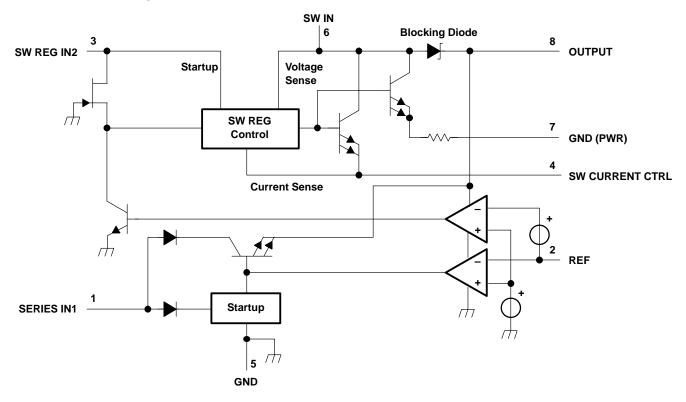
The PS package is available taped and reeled. Add the suffix R to device type (e.g., TL499ACPSR).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



# functional block diagram



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Output voltage, VO (see Note 1)	35 V
Input voltage, series regulator, V <sub>I</sub> 1	35 V
Input voltage, switching regulator, V <sub>1</sub> 2	10 V
Blocking-diode reverse voltage	35 V
Blocking-diode forward current	1 A
Power switch current (SW IN)	1 A
Package thermal impedance, θ <sub>JA</sub> (see Notes 2 and 3): P package	85°C/W
PS package	95°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T <sub>stg</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to network ground terminal.
  - 2. Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.
  - 3. The package thermal impedance is calculated in accordance with JESD 51-7.



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# recommended operating conditions

	MIN	NOM	MAX	UNIT
Output voltage, VO	2.9		30	V
Input voltage, V <sub>I</sub> 1 (SERIES IN1)	4.5		32	V
Input voltage, V <sub>I</sub> 2 (SW REG IN2)	1.1		10	V
Output-to-input differential voltage, switching regulator, VO – VI2 (see Note 4)	1.2		28.9	V
Continuous output current, IO			100	mA
Power switch current (at SW IN)			500	mA
Current-limiting resistor, R <sub>CL</sub>	150		1000	Ω
Filter capacitor	100		470	μF
Pass capacitor		0.1		μF
Inductor, L (dcr $\leq$ 0.1 $\Omega$ )	50		150	μΗ
Operating free-air temperature, T <sub>A</sub>	-20		85	°C

NOTE 4: When operating temperature range is  $T_A \le 70^{\circ}C$ , minimum  $V_O - V_12$  is  $\ge 1.2$  V. When operating temperature range is  $T_A \le 85^{\circ}C$ , minimum  $V_O - V_12$  is  $\ge 1.9$  V.

# electrical characteristics over recommended operating conditions (unless otherwise noted)

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PARAM	IEIEK		IESI CC	ONDITIONS		MIN	TYP	MAX	UNII
Voltage deviation (see	Note 5)				20	30	mV/V		
V <sub>O</sub> – V <sub>I</sub> 2	Switching regulator	$T_A = -20^{\circ}C$ to 7	70°C			1.2			
v() – v 2	Switching regulator	$T_A = -20^{\circ}C \text{ to } 8$	35°C			1.9			V
Dropout voltage	Series regulator	V <sub>I</sub> 1 = 15 V, I <sub>C</sub>	) = 50 mA					1.8	
Reference voltage (inte	V <sub>I</sub> 1 = 5 V, V	O = 3 V,	$I_O = 1 \text{ mA}$		1.2	1.26	1.32	٧	
Reference-voltage cha	inge with temperature						5	10	mV/V
Output regulation (of re	eference voltage)	$I_0 = 1 \text{ mA to } 50$	) mA				10	30	mV/V
		V <sub>I</sub> 2 = 1.1 V, V	O = 12 V,	$R_{CL} = 150 \Omega$ ,	T <sub>A</sub> = 25°C			10	
Output current	Switching regulator	V <sub>I</sub> 2 = 1.5 V, V	O = 15 V,	$R_{CL} = 150 \Omega$ ,	T <sub>A</sub> = 25°C			15	mA
(see Figure 1)		V <sub>I</sub> 2 = 6 V, V	O = 30 V,	$R_{CL} = 150 \Omega$ ,	T <sub>A</sub> = 25°C			65	ША
	Series regulator							100	
Standby current	Switching regulator	V <sub>I</sub> 2 = 3 V, V	O = 9 V,	T <sub>A</sub> = 25°C			15	80	μΑ
Standby current	Series regulator	V <sub>I</sub> 1 = 15 V, V	O = 9 V,	$R_{E}2 = 4.7 \text{ k}\Omega$			0.8	1.2	mA

NOTE 5: Voltage deviation is the output voltage difference that occurs in a change from series regulation to switching regulation: Voltage deviation =  $V_0$ (series regulation) -  $V_0$ (switching regulation)



# **APPLICATION INFORMATION**

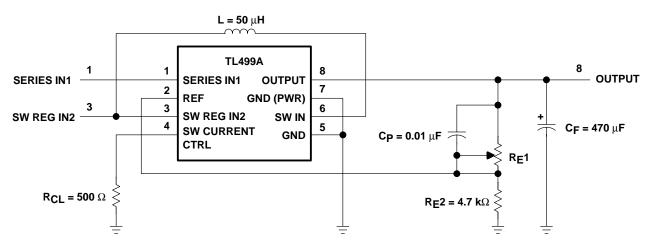


Figure 1. TL499A Basic Configuration

**Table 1. Maximum Output Current vs Input and Output Voltages** for Step-Up Switching Regulator With R<sub>CL</sub> = 150  $\Omega$ 

OUTPUT			SWITCH	IING RE	GULATO	OR INPU (V)	T VOLT	AGE (SV	V REG IN2	2)			
VOLTAGE	1.1	1.2	1.3	1.5	1.7	2	2.5	3	5	6	9		
(V)					OUT	PUT CU (mA)							
30		65 90											
25									50	80	100		
20						20	25	30	80	100	100		
15				15	20	30	45	55	100	100	100		
12	10	15	20	25	30	40	55	70	100	100	100		
10	15	20	25	30	35	45	65	80	100	100			
9	20	25	25	35	40	50	70	90	100	100			
6	30	35	40	45	55	75	95	100					
5	35	40	45	55	70	85	100	100	Circuit of Figure 1, except				
4.5	35	45	50	60	75	95	100	100†	$R_{CL} = 150 \Omega$				
3	55	65†	75†	95†	100†				C <sub>F</sub> = 330 μF				
2.9	60†	70†	75†	100†	100†				С	p = 0.1 µ	ιF		

<sup>†</sup>The difference between the output and input voltage for these combinations is greater than the minimum output-to-input differential-voltage specification at 70°C (1.2 V), but less than the minimum at 85°C (1.9 V).



# **APPLICATION INFORMATION**

Table 2. Maximum Output Current vs Input and Output Voltages for Step-Up Switching Regulator With R<sub>CL</sub> = 200  $\Omega$ 

OUTPUT			SWITCH	IING RE	GULATO	OR INPU (V)	T VOLT	AGE (SV	V REG IN2	2)				
VOLTAGE	1.1	1.2	1.3	1.5 1.7 2 2.5 3 5 6										
(V)		OUTPUT CURRENT (mA)												
30										50	100			
25									50	70	100			
20						15	25	30	70	90	100			
15				10	15	25	35	45	90	100	100			
12	10	10	15	20	25	35	45	60	100	100	100			
10	15	20	20	25	30	40	55	70	100	100				
9	20	20	25	30	35	45	60	80	100					
6	25	30	35	45	50	65	90	100						
5	30	35	40	55	60	75	100	100	Circuit of	Figure 1	, except:			
4.5	35	40	45	55	65	85	100	100†	$R_{CL} = 200 \Omega$					
3	50	55†	65†	80†	90†				$C_F = 330  \mu F$					
2.9	50†	60†	65†	85†	100†				C <sub>P</sub> = 0.1 μF					

<sup>†</sup>The difference between the output and input voltage for these combinations is greater than the minimum output-to-input differential-voltage specification at 70°C (1.2 V), but less than the minimum at 85°C (1.9 V).

Table 3. Maximum Output Current vs Input and Output Voltages for Step-Up Switching Regulator With R<sub>CL</sub> = 300  $\Omega$ 

OUTPUT			SWITCH	IING RE	GULATO	OR INPU (V)	T VOLT	AGE (SV	V REG IN2	2)				
VOLTAGE	1.1	1.2	1.3	1.5	1.7	2	2.5	3	5	6	9			
(V)		OUTPUT CURRENT (mA)												
30		40												
25									40	55	100			
20						10	15	20	55	70	100			
15				10	10	20	30	35	75	95	100			
12	10	10	10	15	20	25	35	45	95	100	100			
10	15	15	15	20	25	30	45	55	100	100				
9	15	15	20	25	30	35	50	60	100	100				
6	25	25	30	35	45	55	70	90						
5	30	30	35	45	50	65	85	100	Circuit of	Figure 1	, except:			
4.5	30	35	40	45	55	70	95	100†	$R_{CL} = 300 \Omega$					
3	45	50†	55†	70†	90†				C <sub>F</sub> = 330 μF					
2.9	45†	50†	60†	75†	95†				C <sub>P</sub> = 0.1 μF					

<sup>†</sup>The difference between the output and input voltage for these combinations is greater than the minimum output-to-input differential-voltage specification at 70°C (1.2 V), but less than the minimum at 85°C (1.9 V).

### APPLICATION INFORMATION

Table 4. Maximum Output Current vs Input and Output Voltages for Step-Up Switching Regulator With R<sub>CL</sub> = 510  $\Omega$ 

OUTPUT			SWITCH	IING RE	GULATO	OR INPU (V)	T VOLT	AGE (SV	V REG IN2	2)		
VOLTAGE	1.1	1.2	1.3	1.5	1.7	2	2.5	3	5	6	9	
(V)					OUT	PUT CU (mA)						
30										30	50	
25									25	40	75	
20									40	55	90	
15							15	20	55	70	100	
12					10	15	25	35	65	80	100	
10				10	20	25	30	40	70	85		
9	10	10	10	15	20	25	35	45	75	100		
6	15	20	20	25	30	35	50	60				
5	20	20	25	30	35	45	55	70	Circuit of	Circuit of Figure 1, except		
4.5	20	25	30	35	40	50	65	90†	$R_{CL} = 510 \Omega$			
3	35	35†	40†	50†	75†				C <sub>F</sub> = 330 μF			
2.9	35†	35†	40†	55†	80†				$C_{P} = 0.1  \mu F$			

<sup>†</sup>The difference between the output and input voltage for these combinations is greater than the minimum output-to-input differential-voltage specification at 70°C (1.2 V), but less than the minimum at 85°C (1.9 V).

Table 5. Maximum Output Current vs Input and Output Voltages for Step-Up Switching Regulator With R<sub>CL</sub> = 1 k $\Omega$ 

OUTPUT			SWITCH	IING RE	GULATO	OR INPU (V)	T VOLT	AGE (SV	V REG IN2	2)		
VOLTAGE	1.1	1.2	1.3	1.5	1.7	2	2.5	3	5	6	9	
(V)					OUT	PUT CU (mA)						
30											35	
25										35	50	
20										60		
15								10	30 45		65	
12								20	40	45	85	
10							15	25	40	55		
9				10	10	15	25	30	45	60		
6	10	10	10	15	20	20	30	35				
5	10	10	15	20	20	25	35	40	Circuit of	Circuit of Figure 1, except		
4.5	15	15	15	20	25	30	40	45†	$R_{CL} = 1 k\Omega$			
3	20	25†	25†	30†	35†				C <sub>F</sub> = 330 μF			
2.9	20†	25†	25†	30†	45†				C <sub>P</sub> = 0.1 μF			

<sup>†</sup>The difference between the output and input voltage for these combinations is greater than the minimum output-to-input differential-voltage specification at 70°C (1.2 V), but less than the minimum at 85°C (1.9 V).







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### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TL499ACP	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TL499ACPE4	ACTIVE	PDIP	Р	8	50	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
TL499ACPSR	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL499ACPSRE4	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TL499ACPSRG4	ACTIVE	SO	PS	8	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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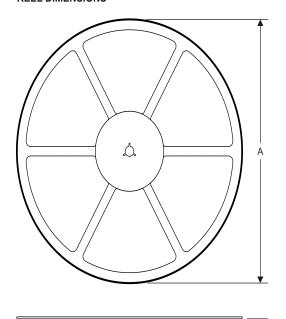
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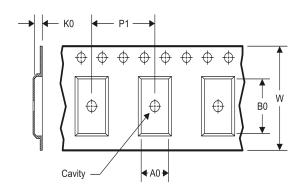
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# TAPE AND REEL INFORMATION

# **REEL DIMENSIONS**



# **TAPE DIMENSIONS**



A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

# TAPE AND REEL INFORMATION

# \*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL499ACPSR	SO	PS	8	2000	330.0	16.4	8.2	6.6	2.5	12.0	16.0	Q1

**PACKAGE MATERIALS INFORMATION** 

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### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL499ACPSR	SO	PS	8	2000	367.0	367.0	38.0

# P (R-PDIP-T8)

# PLASTIC DUAL-IN-LINE PACKAGE



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001 variation BA.





NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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